Intel® NUC Kit

NUC9VXQNX NUC9V7QNX NUC9i9QNX NUC9i7QNX NUC9i5QNX



Regulatory Model: NUC9QN

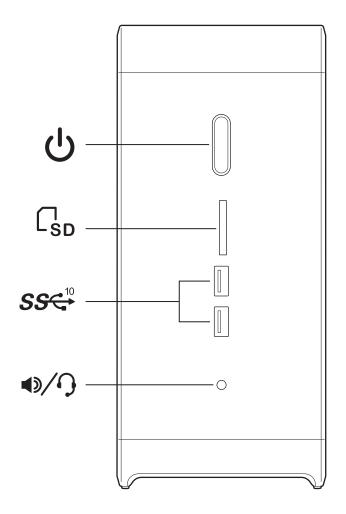
Quick Start Guide



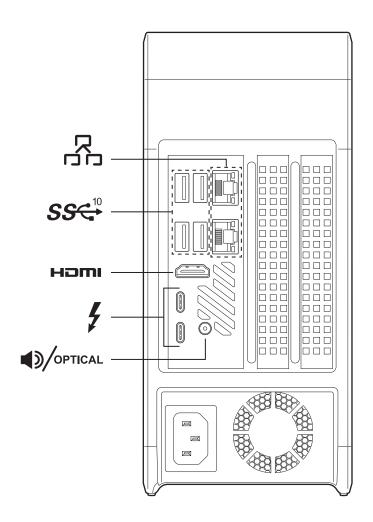
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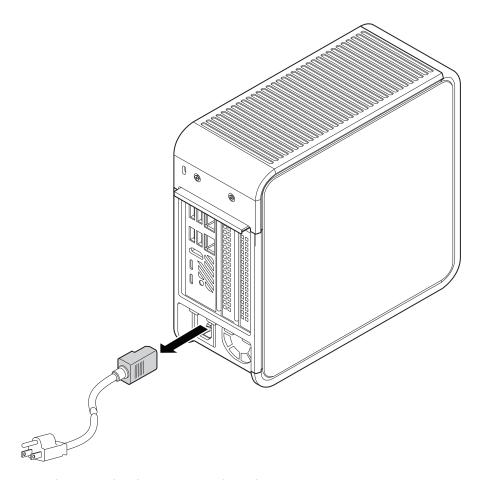
Front View



Rear View



Disconnect System Power Cables



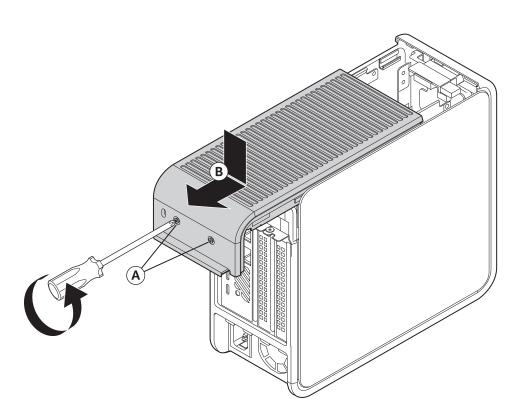
Disconnect the attached power cords, telecommunications systems, networks, and modems before you open or service the device.

장치를 열거나 서비스하기 전에 연결된 전원 코드, 통신 시스템, 네트워크 및 모뎀의 연결을 해제해야 합니다.

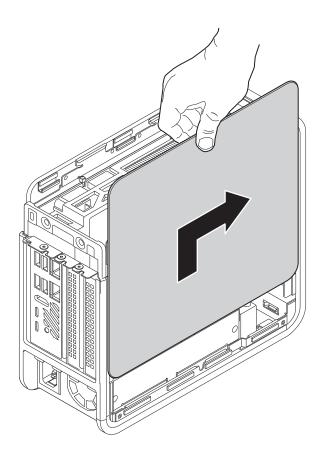
在開啟或保養裝置前,請將所有電源線、電信系統、網路與數據機全部拔除。

Отключите подключенные шнуры питания, телекоммуникационные системы, сети и модемы, прежде чем открывать или обслуживать устройство.

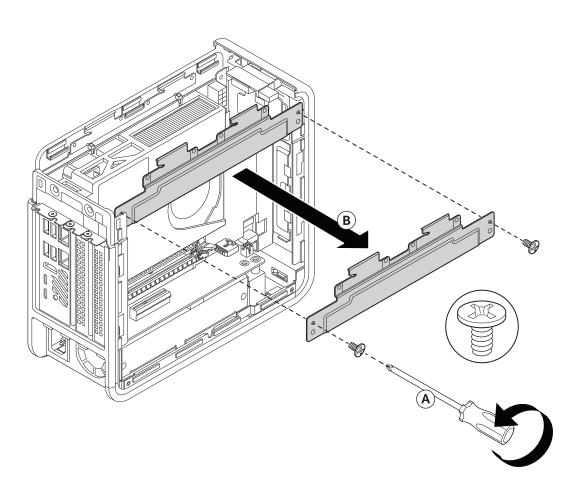
Remove Top Cover/Fan Assembly



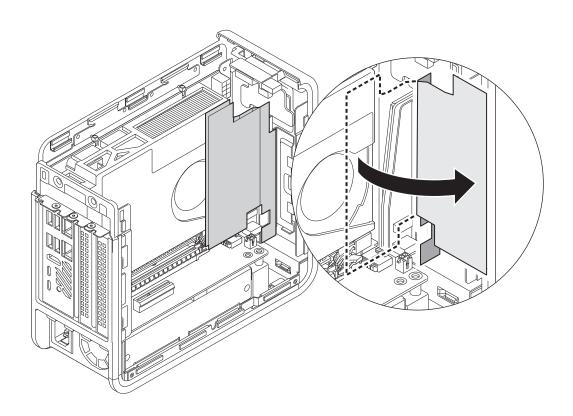
Remove Left Side Panel



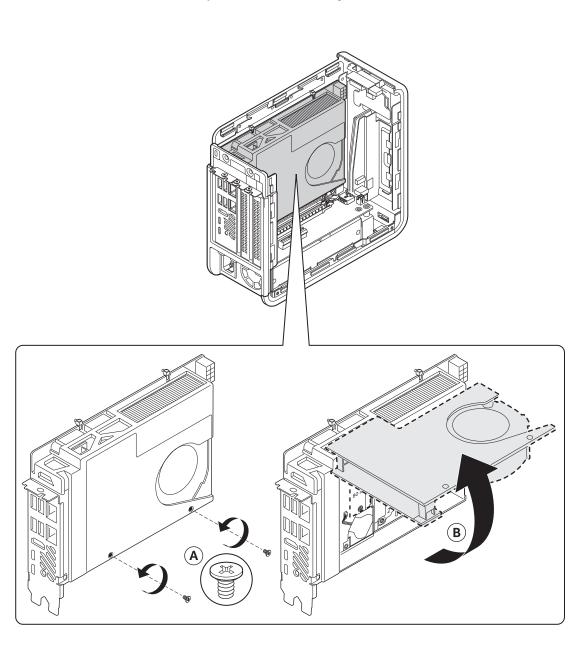
Remove Cross Bar Bracket



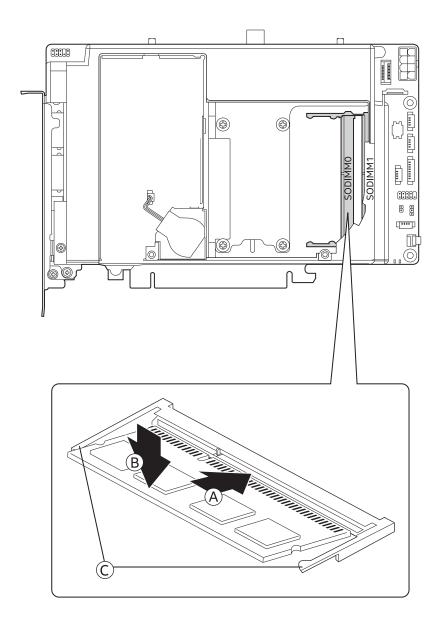
Fold Air Guide Back



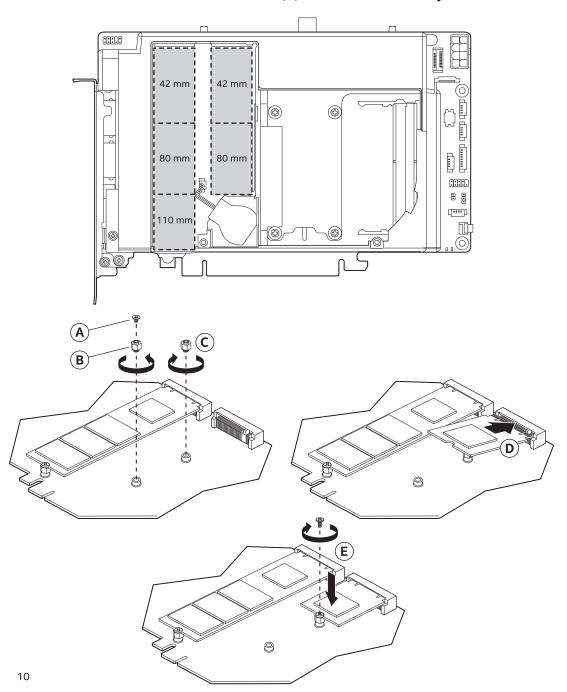
Open Quartz Canyon Door



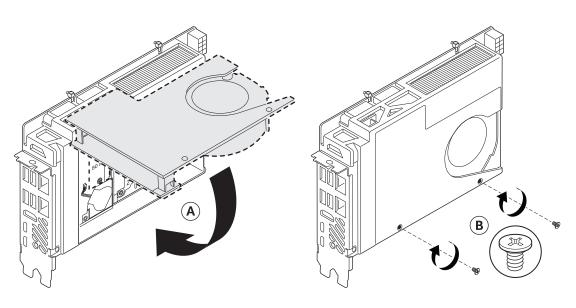
Install Memory into Quartz Canyon

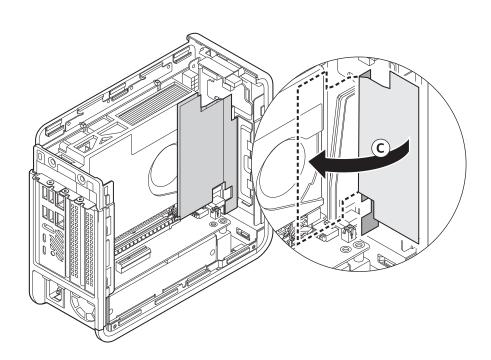


Install M.2 Module(s) into Quartz Canyon

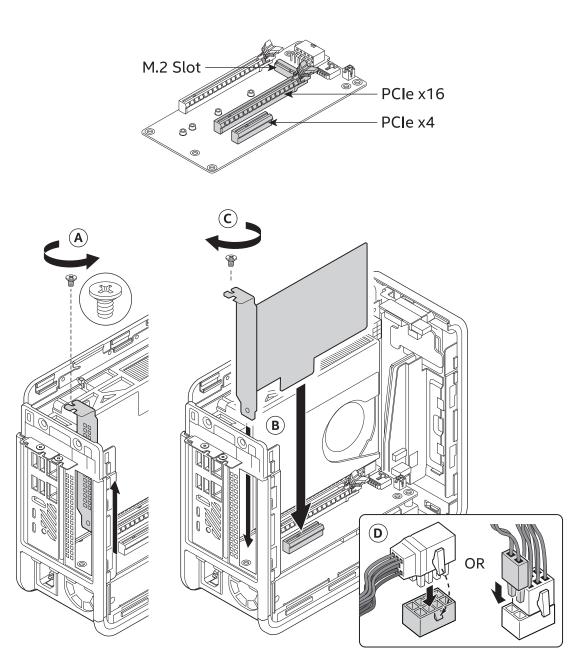


Close Quartz Canyon Door and Fold Air Guide Into Place

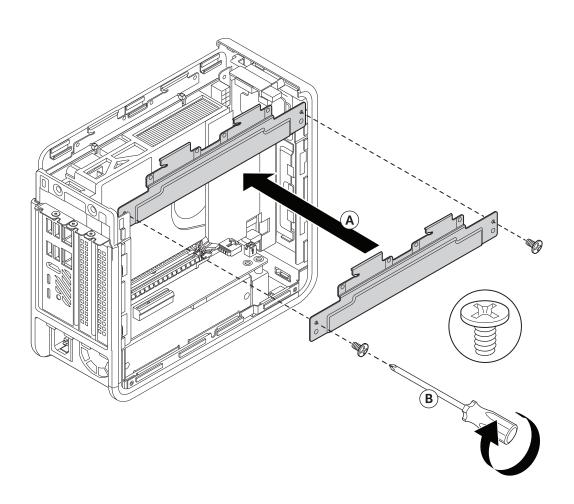




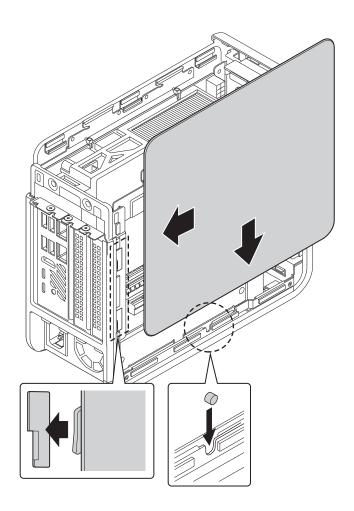
Install Add-In Card



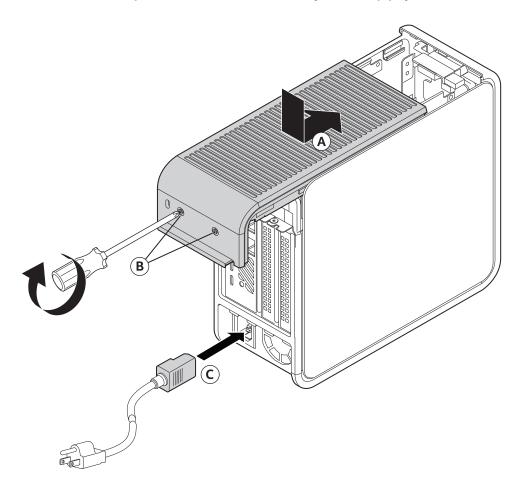
Install Cross Bar Bracket



Install Left Side Panel



Install Top Cover/Fan Assembly and Apply Power Cable



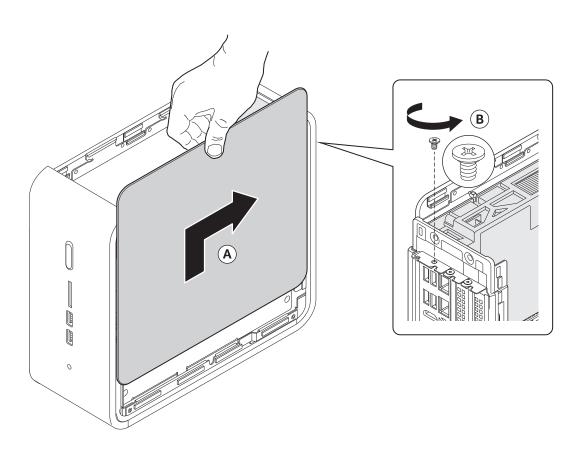
All chassis exterior panels must be installed before power is applied to the chassis.

장치에 전원을 공급하기 전에 모든 섀시 외장 패널을 설치해야 합니다.

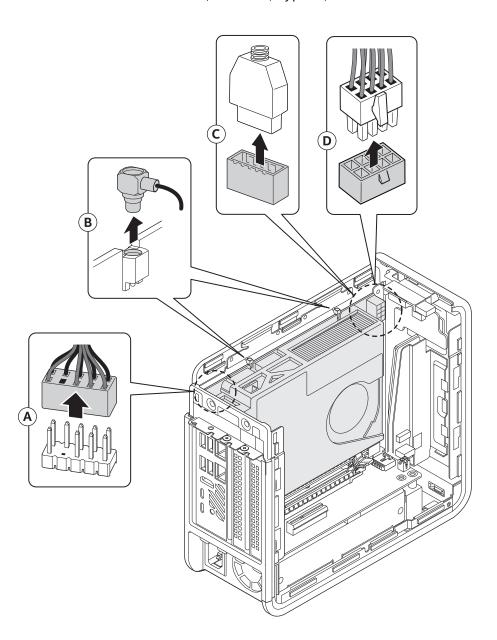
將裝置接上電源前,所有機殼外部面板必須安裝完成。

Все внешние панели корпуса должны быть установлены до подачи питания на устройство.

Install M.2 onto Baseboard Remove Right Side Panel and Rear Retention Screw

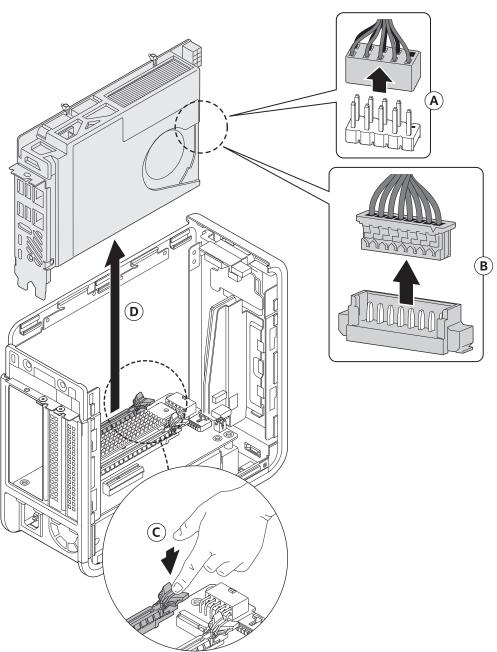


Install M.2 onto Baseboard Disconnect Audio, Antenna, Type-C, and EPS Power Connections

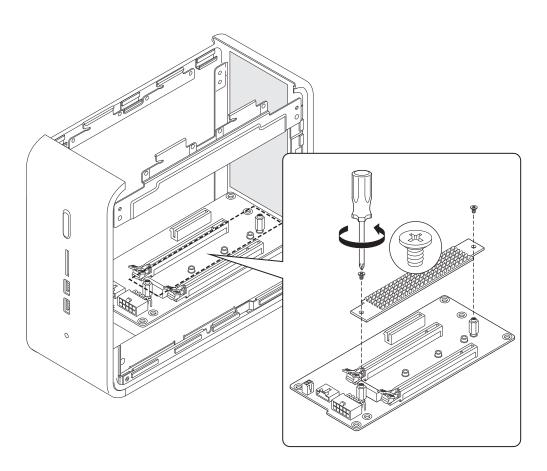


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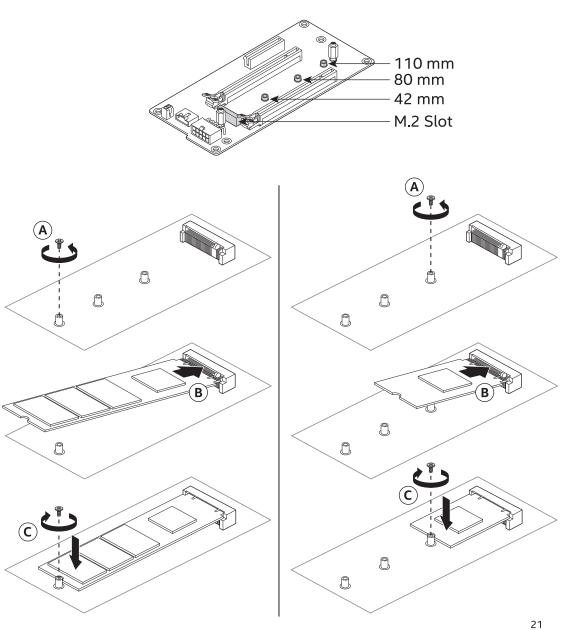
Install M.2 onto Baseboard Disconnect Front Panel and Aux Fan, Remove Quartz Canyon



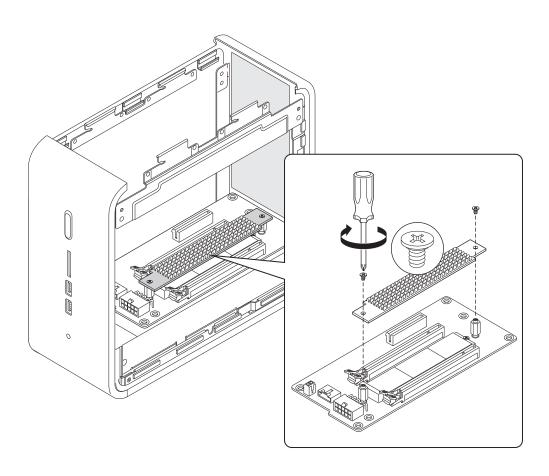
Install M.2 onto Baseboard Remove M.2 Heatsink From Baseboard



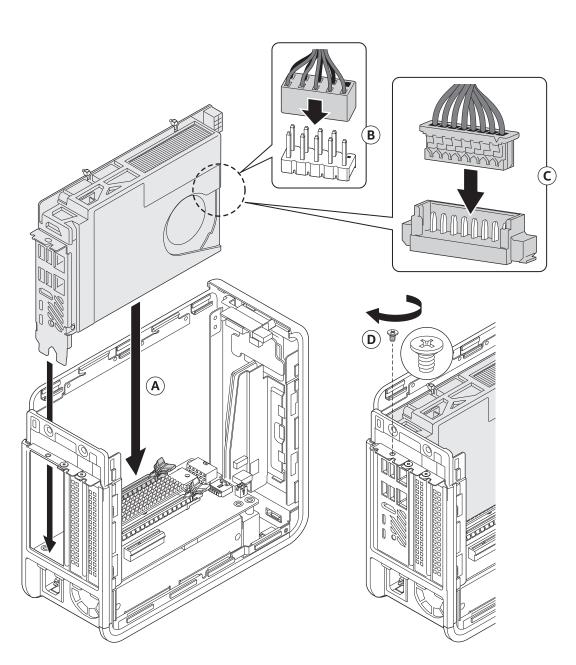
Install M.2 onto Baseboard



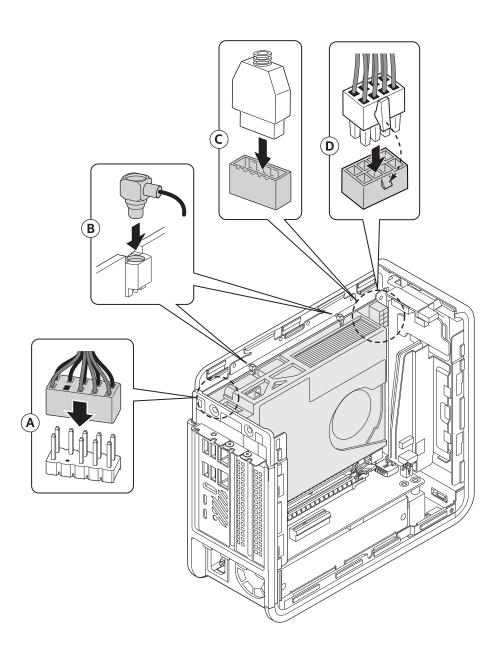
Install M.2 onto Baseboard Reinstall M.2 Heatsink onto Baseboard



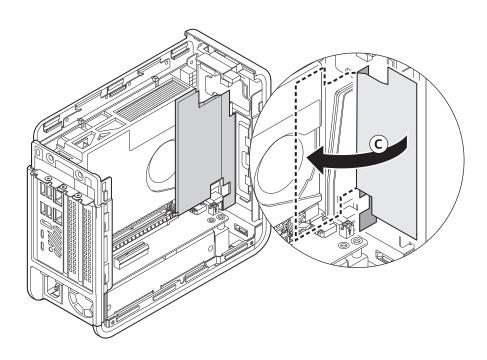
Install M.2 onto Baseboard Reinstall Quartz Canyon and Connect Front Panel and Aux Fan



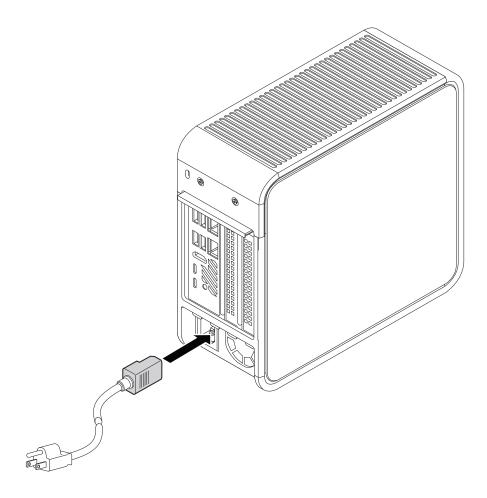
Install M.2 onto Baseboard Reconnect Audio, Antenna, Type-C, and GPU Power Connections



Install M.2 onto Baseboard Fold Air Guide Into Place



Powering the System



All chassis exterior panels must be installed before power is applied to the chassis.

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將裝置接上電源前,所有機殼外部面板必須安裝完成。

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